

**L, S-BAND SPDT SWITCH****DESCRIPTION**

The  $\mu$ PG2160T5K is a GaAs MMIC for L, S-band SPDT (Single Pole Double Throw) switch which was developed for mobile phone and another L, S-band applications.

This device can operate frequency from 0.5 to 3.0 GHz, having the low insertion loss and high isolation.

This device is housed in a 6-pin plastic TSSON (Thin Shrink Small Out-line Non-leaded) package. And this package is able to high-density surface mounting.

**FEATURES**

- Supply voltage :  $V_{DD} = 2.4$  to  $2.8$  V (2.6 V TYP.)
- Switch control voltage :  $V_{cont}(H) = 2.4$  to  $V_{DD}$  (2.6 V TYP.)  
:  $V_{cont}(L) = -0.2$  to  $0.2$  V (0 V TYP.)
- Low insertion loss :  $L_{ins1} = 0.30$  dB TYP. @  $f = 0.5$  to  $1.0$  GHz,  $V_{DD} = 2.6$  V,  $V_{cont}(H) = 2.6$  V,  $V_{cont}(L) = 0$  V  
:  $L_{ins2} = 0.35$  dB TYP. @  $f = 1.0$  to  $2.0$  GHz,  $V_{DD} = 2.6$  V,  $V_{cont}(H) = 2.6$  V,  $V_{cont}(L) = 0$  V  
:  $L_{ins3} = 0.40$  dB TYP. @  $f = 2.0$  to  $2.5$  GHz,  $V_{DD} = 2.6$  V,  $V_{cont}(H) = 2.6$  V,  $V_{cont}(L) = 0$  V  
:  $L_{ins4} = 0.50$  dB TYP. @  $f = 2.5$  to  $3.0$  GHz,  $V_{DD} = 2.6$  V,  $V_{cont}(H) = 2.6$  V,  $V_{cont}(L) = 0$  V
- High isolation :  $ISL1 = 25$  dB TYP. @  $f = 0.5$  to  $1.0$  GHz,  $V_{DD} = 2.6$  V,  $V_{cont}(H) = 2.6$  V,  $V_{cont}(L) = 0$  V  
:  $ISL2 = 18$  dB TYP. @  $f = 1.0$  to  $2.0$  GHz,  $V_{DD} = 2.6$  V,  $V_{cont}(H) = 2.6$  V,  $V_{cont}(L) = 0$  V  
:  $ISL3 = 17$  dB TYP. @  $f = 2.0$  to  $2.5$  GHz,  $V_{DD} = 2.6$  V,  $V_{cont}(H) = 2.6$  V,  $V_{cont}(L) = 0$  V  
:  $ISL4 = 13$  dB TYP. @  $f = 2.5$  to  $3.0$  GHz,  $V_{DD} = 2.6$  V,  $V_{cont}(H) = 2.6$  V,  $V_{cont}(L) = 0$  V
- Handling power :  $P_{in}(0.1\text{ dB}) = +21.0$  dBm TYP. @  $f = 2.0/2.5$  GHz,  $V_{DD} = 2.6$  V,  $V_{cont}(H) = 2.6$  V,  $V_{cont}(L) = 0$  V
- High-density surface mounting : 6-pin plastic TSSON package ( $1.0 \times 1.0 \times 0.37$  mm)

**APPLICATIONS**

- L, S-band digital cellular or cordless telephone
- W-LAN, WLL and Bluetooth™ etc.

**ORDERING INFORMATION**

Part Number	Order Number	Package	Marking	Supplying Form
$\mu$ PG2160T5K-E2	$\mu$ PG2160T5K-E2-A	6-pin plastic TSSON (Pb-Free) <sup>Note</sup>	G4	<ul style="list-style-type: none"> <li>• Embossed tape 8 mm wide</li> <li>• Pin 1, 6 face the perforation side of the tape</li> <li>• Qty 5 kpcs/reel</li> </ul>

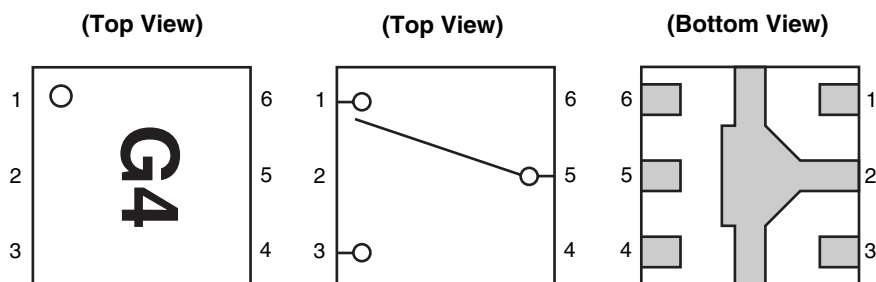
**Note** With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

**Remark** To order evaluation samples, contact your nearby sales office.  
Part number for sample order:  $\mu$ PG2160T5K

**Caution** Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.

# PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	OUTPUT1
2	GND
3	OUTPUT2
4	V <sub>cont</sub>
5	INPUT
6	V <sub>DD</sub>

## TRUTH TABLE

V <sub>cont</sub>	INPUT-OUTPUT1	INPUT-OUTPUT2
High	OFF	ON
Low	ON	OFF

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V <sub>DD</sub>	+6.0	V
Switch Control Voltage	V <sub>cont</sub>	+6.0	V
Input Power	P <sub>in</sub>	+26	dBm
Operating Ambient Temperature	T <sub>A</sub>	−45 to +85	°C
Storage Temperature	T <sub>stg</sub>	−55 to +135	°C

## RECOMMENDED OPERATING RANGE (T<sub>A</sub> = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage <sup>Note</sup>	V <sub>DD</sub>	2.4	2.6	2.8	V
Switch Control Voltage (H) <sup>Note</sup>	V <sub>cont</sub> (H)	2.4	2.6	V <sub>DD</sub>	V
Switch Control Voltage (L)	V <sub>cont</sub> (L)	−0.2	0	0.2	V

**Note** V<sub>cont</sub> (H) ≤ V<sub>DD</sub>

# ELECTRICAL CHARACTERISTICS

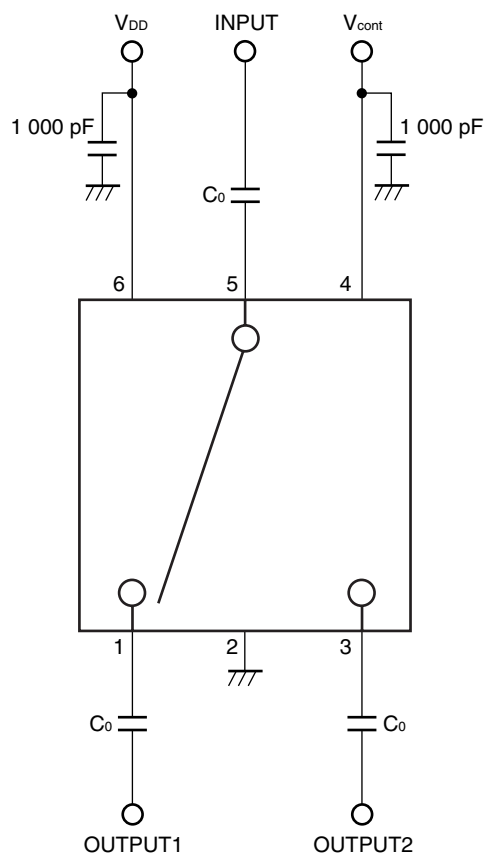
( $T_A = +25^{\circ}\text{C}$ ,  $V_{DD} = 2.6\text{ V}$ ,  $V_{\text{cont}}(\text{H}) = 2.6\text{ V}$ ,  $V_{\text{cont}}(\text{L}) = 0\text{ V}$ , DC cut capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	$L_{\text{ins1}}$	$f = 0.5\text{ to }1.0\text{ GHz}$	–	0.30	0.45	dB
Insertion Loss 2	$L_{\text{ins2}}$	$f = 1.0\text{ to }2.0\text{ GHz}$	–	0.35	0.50	
Insertion Loss 3	$L_{\text{ins3}}$	$f = 2.0\text{ to }2.5\text{ GHz}$	–	0.40	0.55	
Insertion Loss 4	$L_{\text{ins4}}$	$f = 2.5\text{ to }3.0\text{ GHz}$	–	0.50	0.65	
Isolation 1	ISL1	$f = 0.5\text{ to }1.0\text{ GHz}$	22	25	–	dB
Isolation 2	ISL2	$f = 1.0\text{ to }2.0\text{ GHz}$	15	18	–	
Isolation 3	ISL3	$f = 2.0\text{ to }2.5\text{ GHz}$	14	17	–	
Isolation 4	ISL4	$f = 2.5\text{ to }3.0\text{ GHz}$	10	13	–	
Input Return Loss	$RL_{\text{in}}$	$f = 0.5\text{ to }3.0\text{ GHz}$	15	20	–	dB
Output Return Loss	$RL_{\text{out}}$	$f = 0.5\text{ to }3.0\text{ GHz}$	15	20	–	dB
0.1 dB Loss Compression Input Power <sup>Note</sup>	$P_{\text{in}}(0.1\text{ dB})$	$f = 2.0/2.5\text{ GHz}$	+18.0	+21.0	–	dBm
2nd Harmonics	$2f_0$	$f = 2.0/2.5\text{ GHz}$ , $P_{\text{in}} = +10\text{ dBm}$	65	75	–	dBc
3rd Harmonics	$3f_0$	$f = 2.0/2.5\text{ GHz}$ , $P_{\text{in}} = +10\text{ dBm}$	65	75	–	dBc
Supply Current	$I_{DD}$	No signal	–	50	100	$\mu\text{A}$
Switch Control Current	$I_{\text{cont}}$		–	4	20	$\mu\text{A}$
Switch Control Speed	$t_{\text{sw}}$	50% CTL to 90/10% RF	–	150	–	ns

**Note**  $P_{\text{in}}(0.1\text{ dB})$  is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.

**Caution** This device is used it is necessary to use DC cut capacitors.

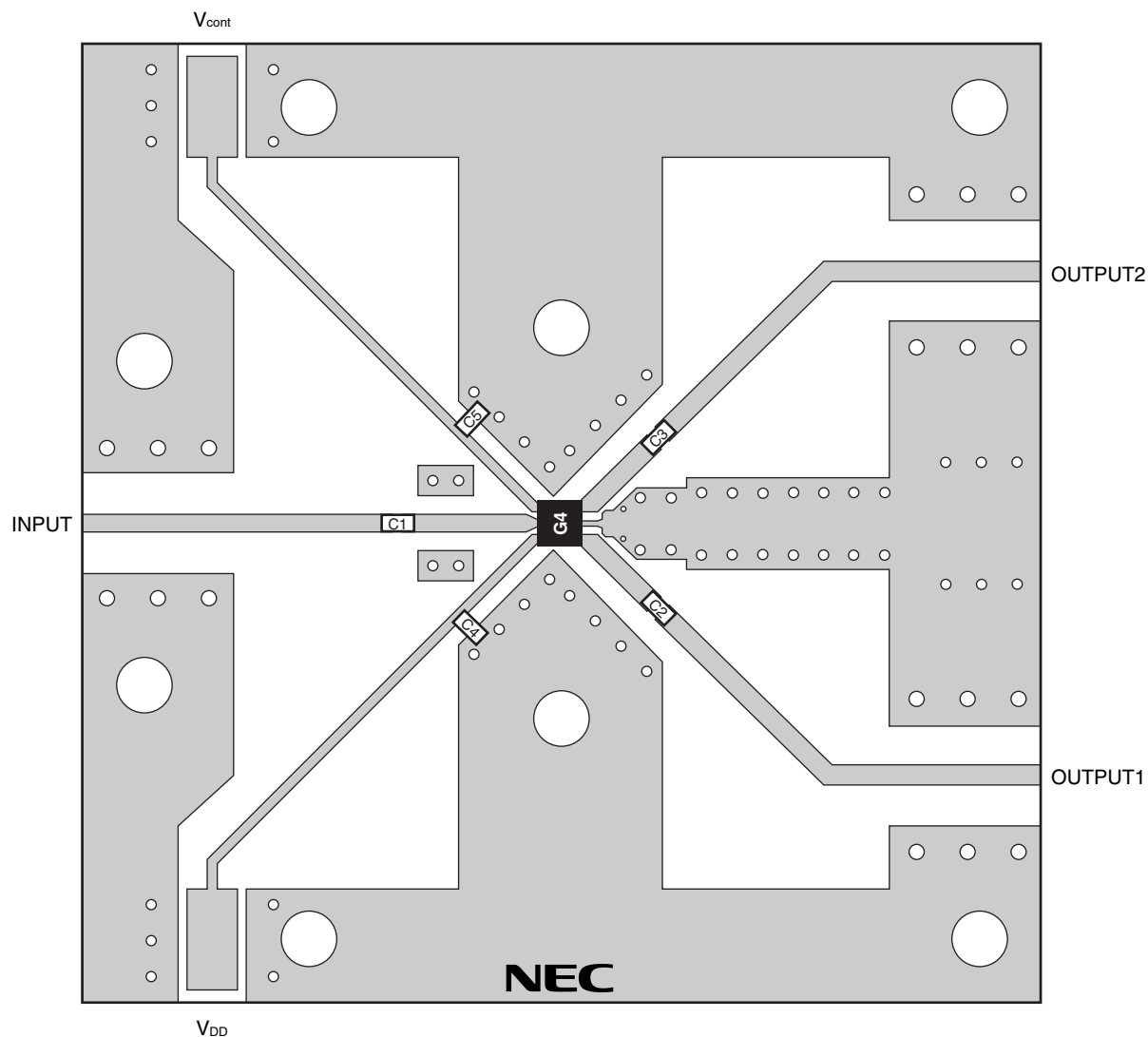
# EVALUATION CIRCUIT



**Remark**  $C_0$  : 56 pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

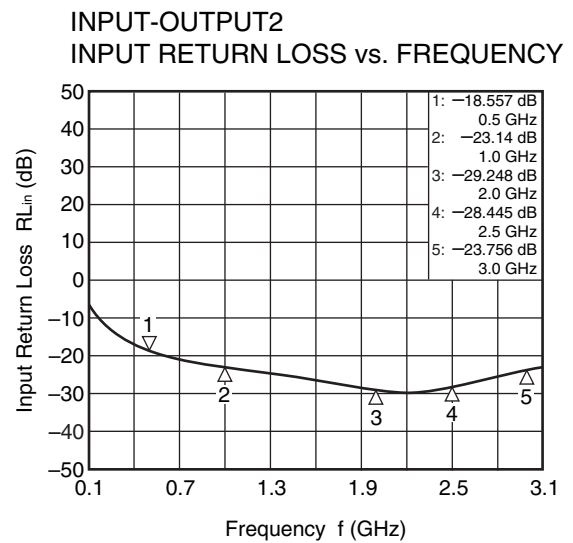
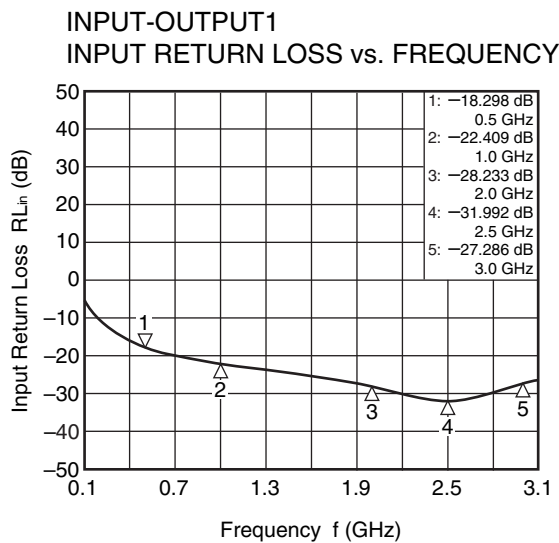
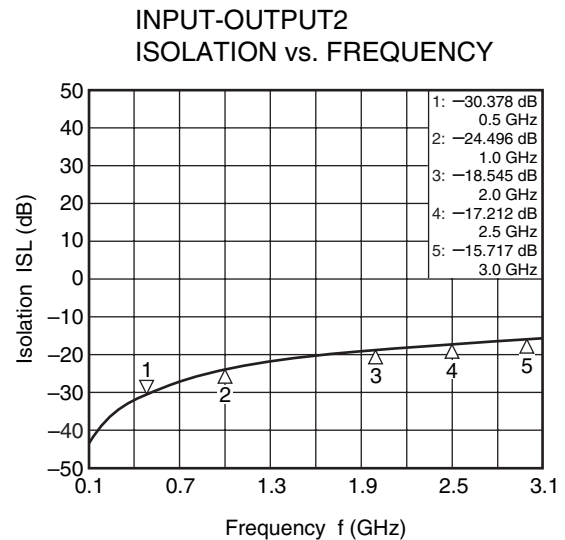
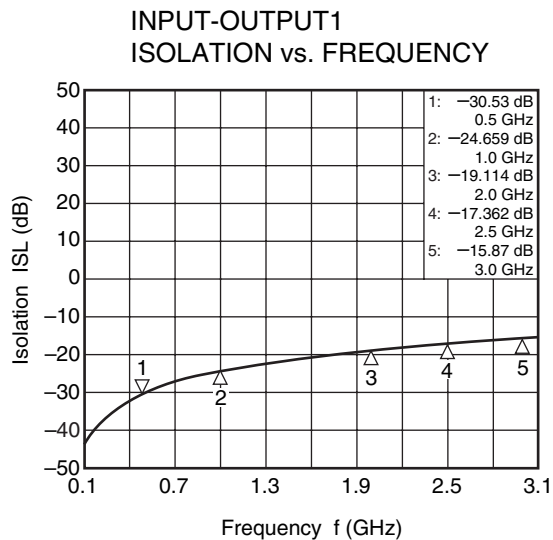
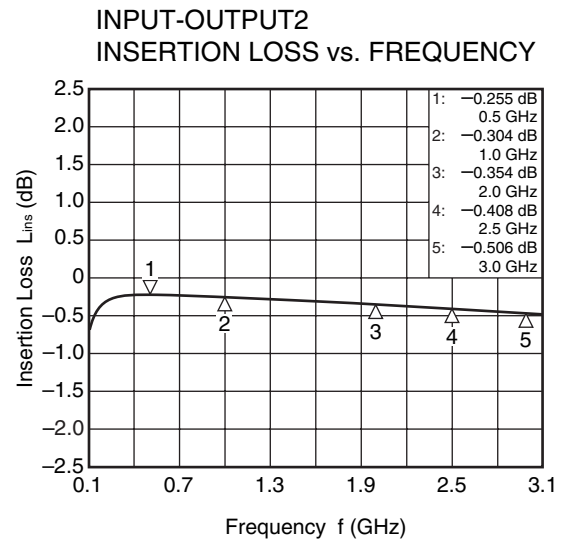
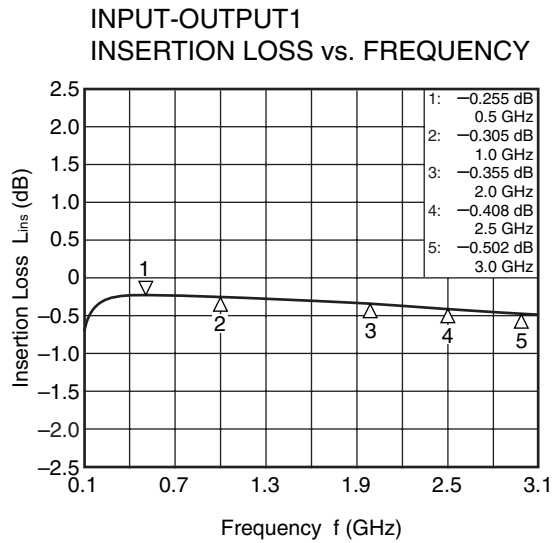
ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD



USING THE NEC EVALUATION BOARD

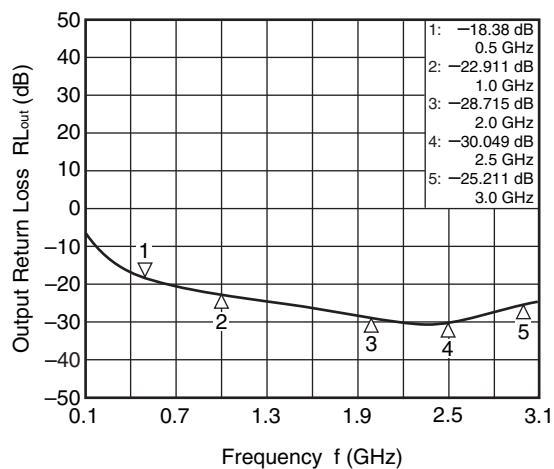
Symbol	Values
C1, C2, C3	56 pF
C4, C5	1 000 pF

**TYPICAL CHARACTERISTICS** ( $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 2.6\text{ V}$ ,  $V_{\text{cont}}(\text{H}) = 2.6\text{ V}$ ,  $V_{\text{cont}}(\text{L}) = 0\text{ V}$ , DC cut capacitors = 56 pF, using test fixture, unless otherwise specified)

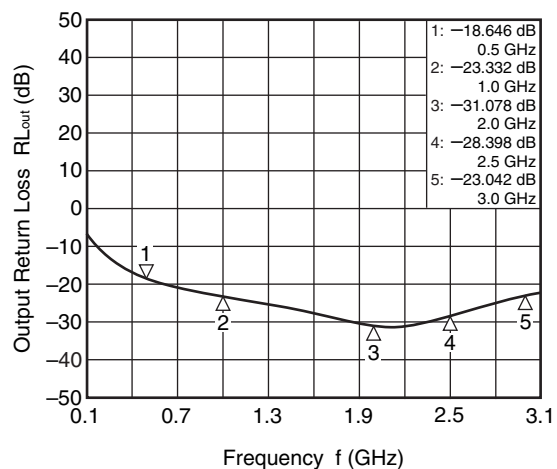


**Remark** The graphs indicate nominal characteristics.

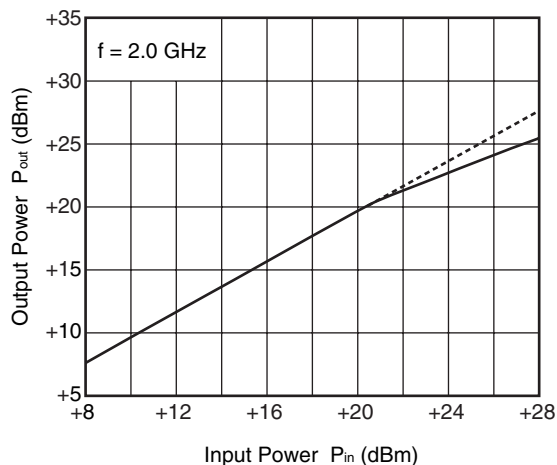
INPUT-OUTPUT1  
OUTPUT RETURN LOSS vs. FREQUENCY



INPUT-OUTPUT2  
OUTPUT RETURN LOSS vs. FREQUENCY



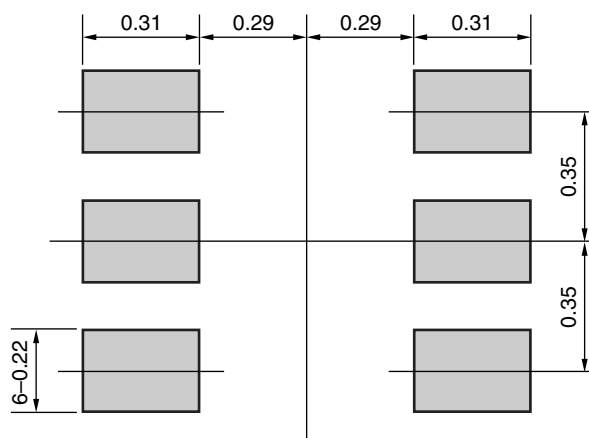
OUTPUT POWER vs. INPUT POWER



**Remark** The graphs indicate nominal characteristics.

# MOUNTING PAD DIMENSIONS

## 6-PIN PLASTIC TSSOP (UNIT: mm)



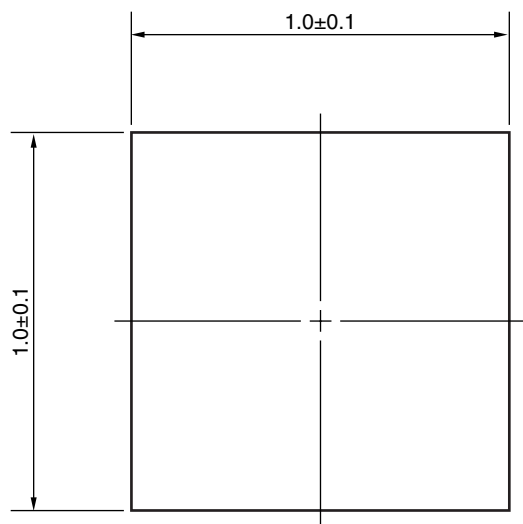
**Remark** The mounting pad layouts in this document are for reference only.



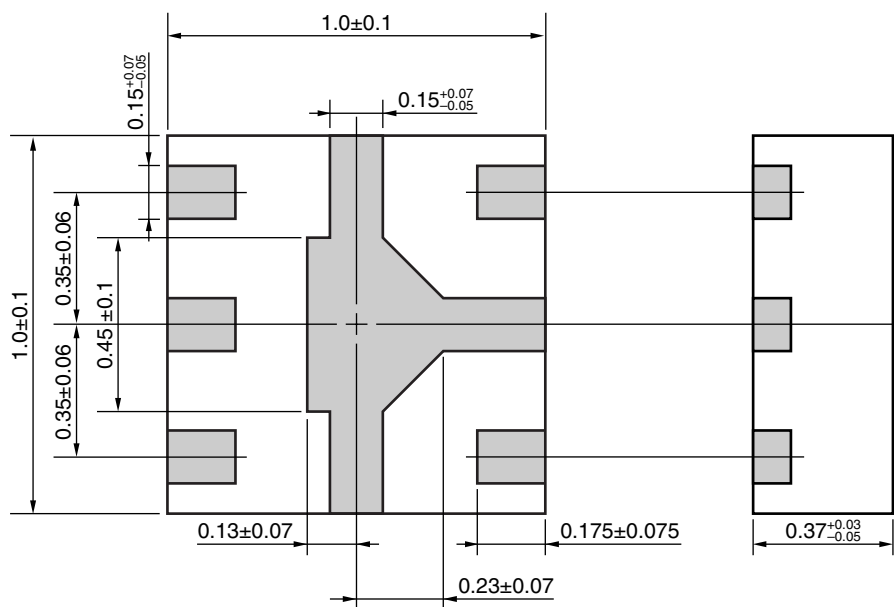
PACKAGE DIMENSIONS

6-PIN PLASTIC TSSOP (UNIT: mm)

(Top View)



(Bottom View)



**RECOMMENDED SOLDERING CONDITIONS**

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) : 260°C or below Time at peak temperature : 10 seconds or less Time at temperature of 220°C or higher : 60 seconds or less Preheating time at 120 to 180°C : 120±30 seconds Maximum number of reflow processes : 3 times Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) : 260°C or below Time at peak temperature : 10 seconds or less Preheating temperature (package surface temperature) : 120°C or below Maximum number of flow processes : 1 time Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) : 350°C or below Soldering time (per side of device) : 3 seconds or less Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	HS350

**Caution** Do not use different soldering methods together (except for partial heating).

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► For further information, please contact

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